TO:

: Examiner Lee

Fax No.

: 703-308-7722

FROM

Robert D. Watson, Agent for Applicants

Applicant

: Peterson

Application No.: 09/955,722

Filed

: 9/18/01

Title

: Temporary Coatings for Protection of Microelectronic

Devices During Packaging

Art Unit

: 2815

Examiner

: Eugene Lee

Docket No. :

SD-6436.1

Number of Pages (Including Cover Sheet)

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T-578 P.002/003 F-156

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FROM-Sandia Nationalists 6401/6413/6415

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Commissioner for Patents Washington DC 20231

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Response to Restriction Requirement

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Sir:

Claims 1-34 are pending in this application.

In response to the restriction requirement in the Office Action of 7/15/02, applicants elect the invention of Embodiment II (Fig. 2A-2E), Claims 1-25 and Claims 28-30, with traverse.

Embodiment II (Fig. 2A-2D) illustrates an example of a wafer with a temporary protective coating. Embodiment I (Fig. 1A-1D and Fig. 2F) illustrates an example of a die with a temporary protective coating. Dies are pieces of wafers that have been sliced and diced into smaller parts. In this sense, a "die" is a subset of a wafer.

Claims 25-27 are drawn to a die with a temporary protective coating, i.e., Embodiment I (Fig. 1A-1D and Fig. 2F). Since a die is a piece or subset of a wafer, Embodiment I and II describe a single invention, namely, a wafer, or part of a wafer, with a temporary protective coating.

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ation No. 09/955,722

Hence, a single search of the prior art should be sufficient to cover both embodiments adequately, without placing an undue burden on the Examiner.

Accordingly, applicant's request that Claims 25-27 be examined along with elected Claims 1-25 and 28-30.

Respectfully submitted,

Robert D. Watson

Agent for Applicants

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Date: August 8, 2003 By: Shall I Greene